



ESD



TVS



MOS



LDO



Diode



Sensor



DC-DC

## Product Specification

▶ Domestic Part Number	FDV301N
▶ Overseas Part Number	FDV301N
▶ Equivalent Part Number	FDV301N

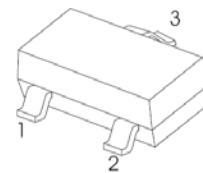


**FEATURES**

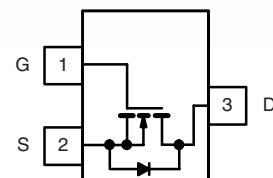
- $V_{DS} (V) = 20V$
- $I_D = 6 A (V_{GS} = 10V)$
- $R_{DS(ON)} < 28m\Omega (V_{GS} = 4.5V)$
- $R_{DS(ON)} < 42m\Omega (V_{GS} = 2.5V)$
- $R_{DS(ON)} < 50m\Omega (V_{GS} = 1.8V)$

**APPLICATIONS**

- DC/DC Converters
- Load Switch for Portable Applications

**SOT - 23**

1. GATE  
2. SOURCE  
3. DRAIN



Top View

**ABSOLUTE MAXIMUM RATINGS**  $T_A = 25^\circ C$ , unless otherwise noted

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	20	V
Gate-Source Voltage	$V_{GS}$	$\pm 12$	
Continuous Drain Current ( $T_J = 150^\circ C$ )	$I_D$	6 <sup>a</sup>	A
		5.1	
		5 <sup>b, c</sup>	
		4 <sup>b, c</sup>	
Pulsed Drain Current	$I_{DM}$	20	
Continuous Source-Drain Diode Current	$I_S$	1.75	
		1.04 <sup>b, c</sup>	
Maximum Power Dissipation	$P_D$	2.1	W
		1.3	
		1.25 <sup>b, c</sup>	
		0.8 <sup>b, c</sup>	
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	- 55 to 150	°C
Soldering Recommendations (Peak Temperature)		260	

**THERMAL RESISTANCE RATINGS**

Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>b, d</sup>	$R_{thJA}$	80	100	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	40	

Notes:

- Package limited
- Surface Mounted on 1" x 1" FR4 board.
- t = 5 s.
- Maximum under steady state conditions is 125 °C/W.
- Based on  $T_C = 25^\circ C$ .

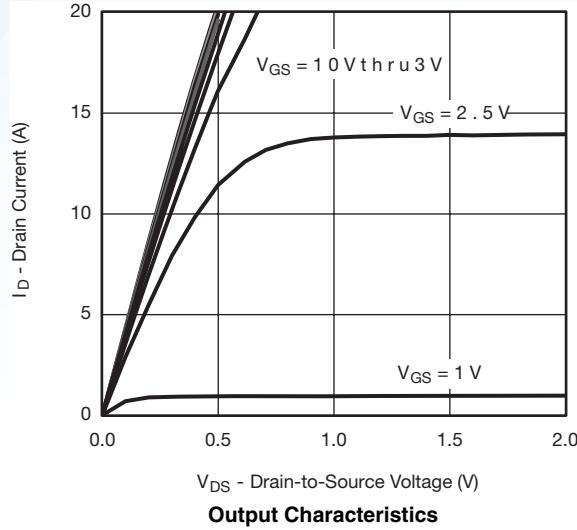
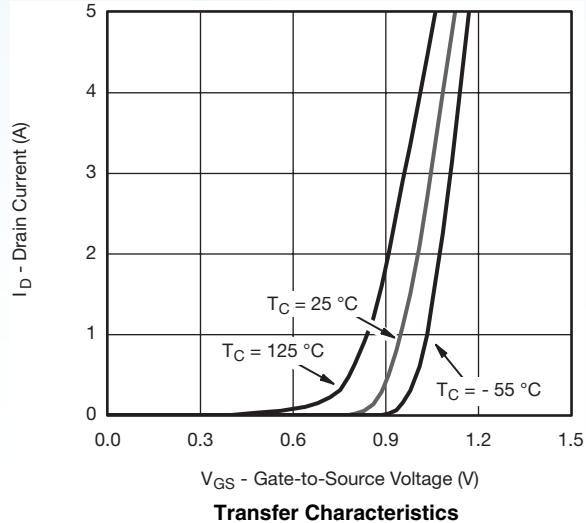
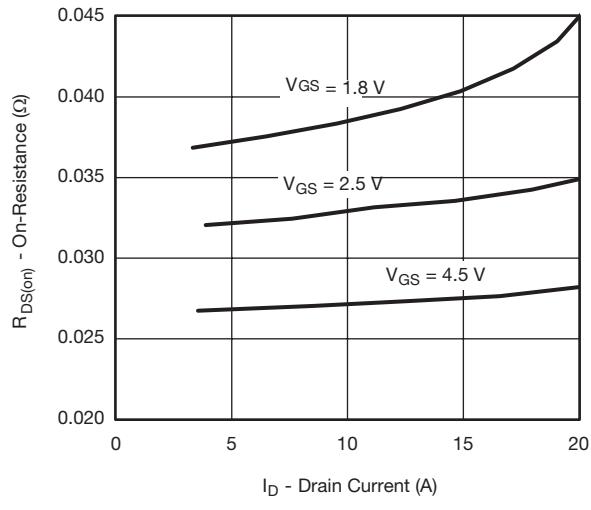
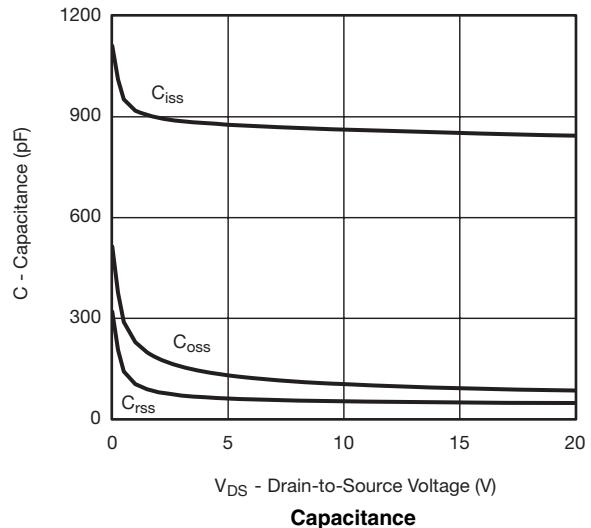
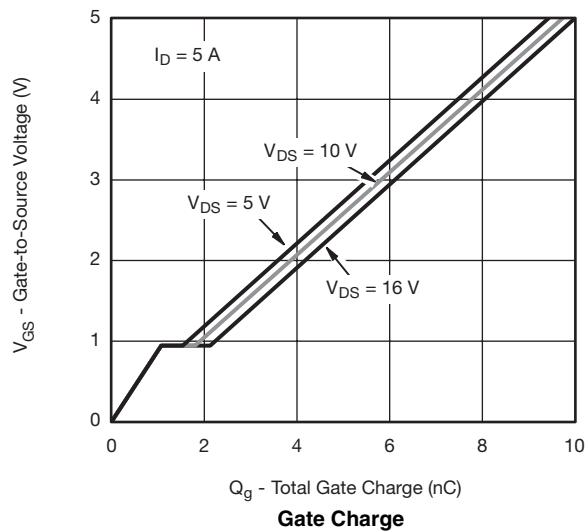
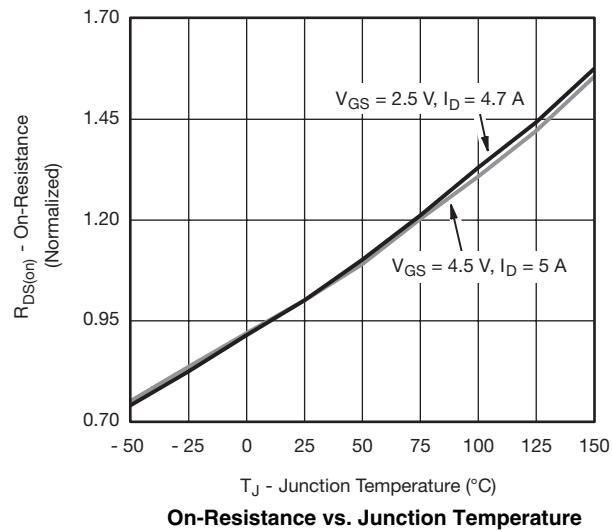
## N-Channel 20 V (D-S) MOSFET

**SPECIFICATIONS**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit	
<b>Static</b>							
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20			V	
$V_{DS}$ Temperature Coefficient	$\Delta V_{DS}/T_J$	$I_D = 250 \mu\text{A}$		25		$\text{mV}/^\circ\text{C}$	
$V_{GS(\text{th})}$ Temperature Coefficient	$\Delta V_{GS(\text{th})}/T_J$			- 2.6			
Gate-Source Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	0.45		1.0	V	
Gate-Source Leakage	$I_{GSS}$	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			$\pm 100$	nA	
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$		1		$\mu\text{A}$	
		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 70^\circ\text{C}$			10		
On-State Drain Current <sup>a</sup>	$I_{D(\text{on})}$	$V_{DS} \leq 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	20			A	
Drain-Source On-State Resistance <sup>a</sup>	$R_{DS(\text{on})}$	$V_{GS} = 4.5 \text{ V}, I_D = 5.0 \text{ A}$		28		$\text{m}\Omega$	
		$V_{GS} = 2.5 \text{ V}, I_D = 4.7 \text{ A}$		42			
		$V_{GS} = 1.8 \text{ V}, I_D = 4.3 \text{ A}$		50			
Forward Transconductance <sup>a</sup>	$g_{fs}$	$V_{DS} = 10 \text{ V}, I_D = 5.0 \text{ A}$		24		S	
<b>Dynamic<sup>b</sup></b>							
Input Capacitance	$C_{iss}$	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		865		$\text{pF}$	
Output Capacitance	$C_{oss}$			105			
Reverse Transfer Capacitance	$C_{rss}$			55			
Total Gate Charge	$Q_g$	$V_{DS} = 10 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 5.0 \text{ A}$		12	18	$\text{nC}$	
Gate-Source Charge	$Q_{gs}$			8.8	14		
Gate-Drain Charge	$Q_{gd}$			1.1			
Gate Resistance	$R_g$			0.7			
Turn-On Delay Time	$t_{d(\text{on})}$	$V_{DD} = 10 \text{ V}, R_L = 2.2 \Omega$ $I_D \geq 4 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		0.5	2.4	4.8	$\Omega$
Rise Time	$t_r$			8	16		$\text{ns}$
Turn-Off Delay Time	$t_{d(\text{off})}$			17	26		
Fall Time	$t_f$			31	47		
Turn-On Delay Time	$t_{d(\text{on})}$			8	16		
Rise Time	$t_r$			5	10		
Turn-Off Delay Time	$t_{d(\text{off})}$			13	20		
Fall Time	$t_f$			21	32		
<b>Drain-Source Body Diode Characteristics</b>							
Continuous Source-Drain Diode Current	$I_S$	$T_C = 25^\circ\text{C}$			1.75	$\text{A}$	
Pulse Diode Forward Current	$I_{SM}$				20		
Body Diode Voltage	$V_{SD}$	$I_S = 4 \text{ A}, V_{GS} = 0 \text{ V}$		0.75	1.2	V	
Body Diode Reverse Recovery Time	$t_{rr}$	$I_F = 4 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}, T_J = 25^\circ\text{C}$		12	20	$\text{ns}$	
Body Diode Reverse Recovery Charge	$Q_{rr}$			5	10	$\text{nC}$	
Reverse Recovery Fall Time	$t_a$			7		$\text{ns}$	
Reverse Recovery Rise Time	$t_b$			5			

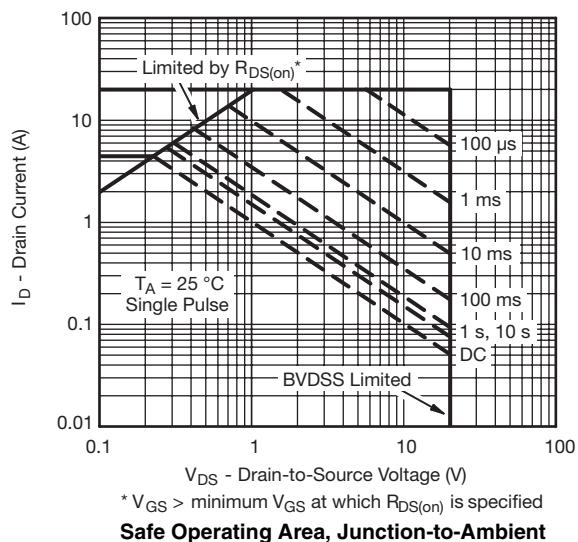
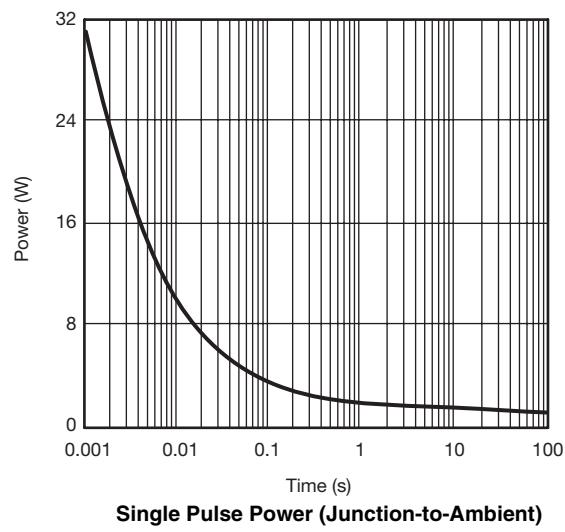
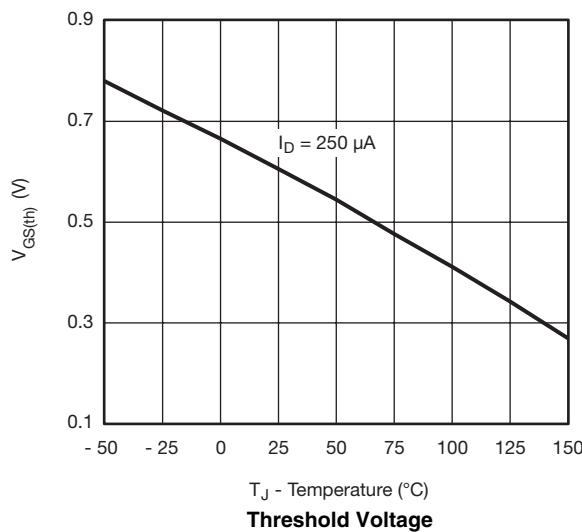
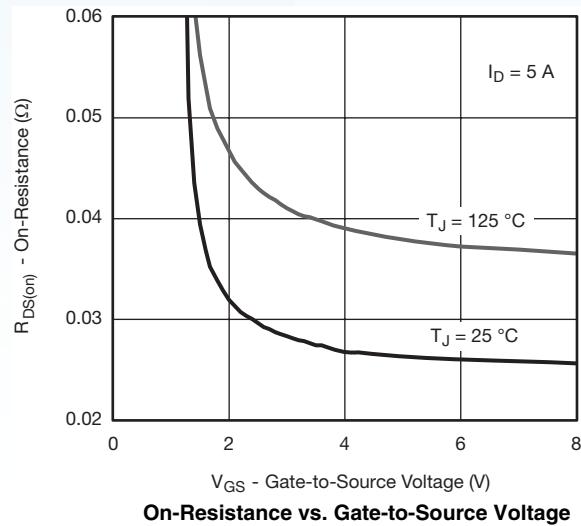
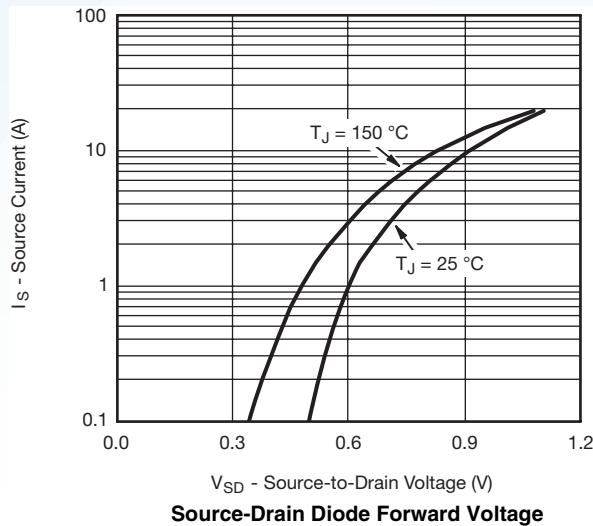
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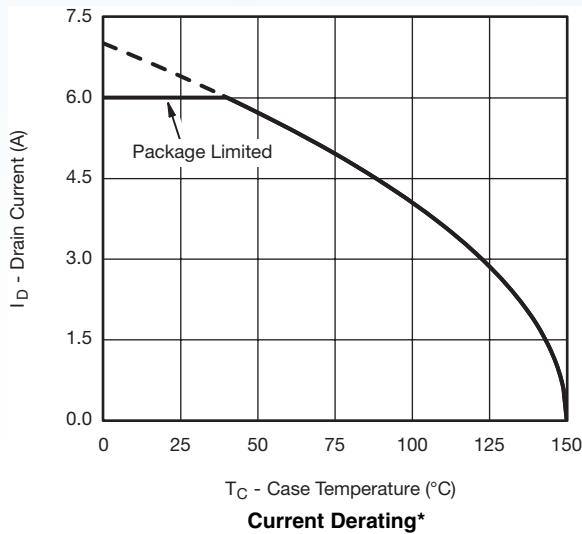
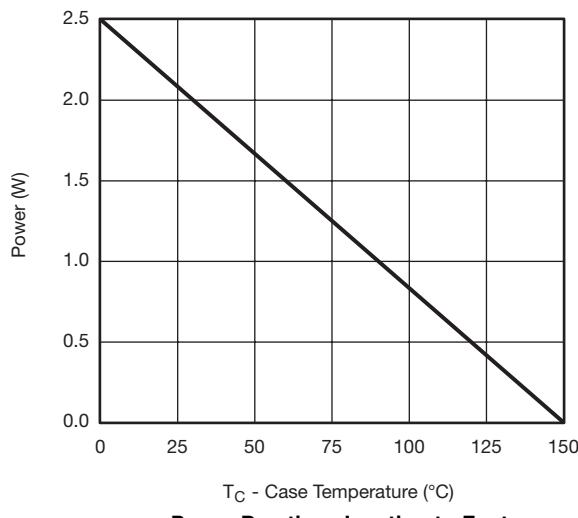
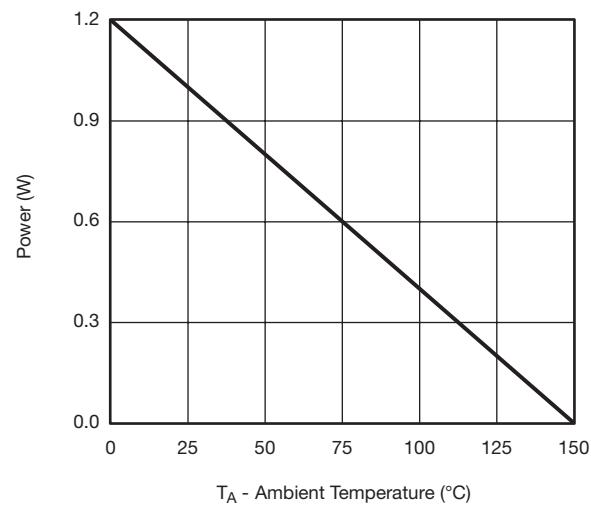
- a. Pulse test; pulse width  $\leq 300 \mu\text{s}$ , duty cycle  $\leq 2\%$
- b. Guaranteed by design, not subject to production testing.

**N-Channel 20 V (D-S) MOSFET**
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted
**Output Characteristics****Transfer Characteristics****On-Resistance vs. Drain Current and Gate Voltage****Capacitance****Gate Charge****On-Resistance vs. Junction Temperature**

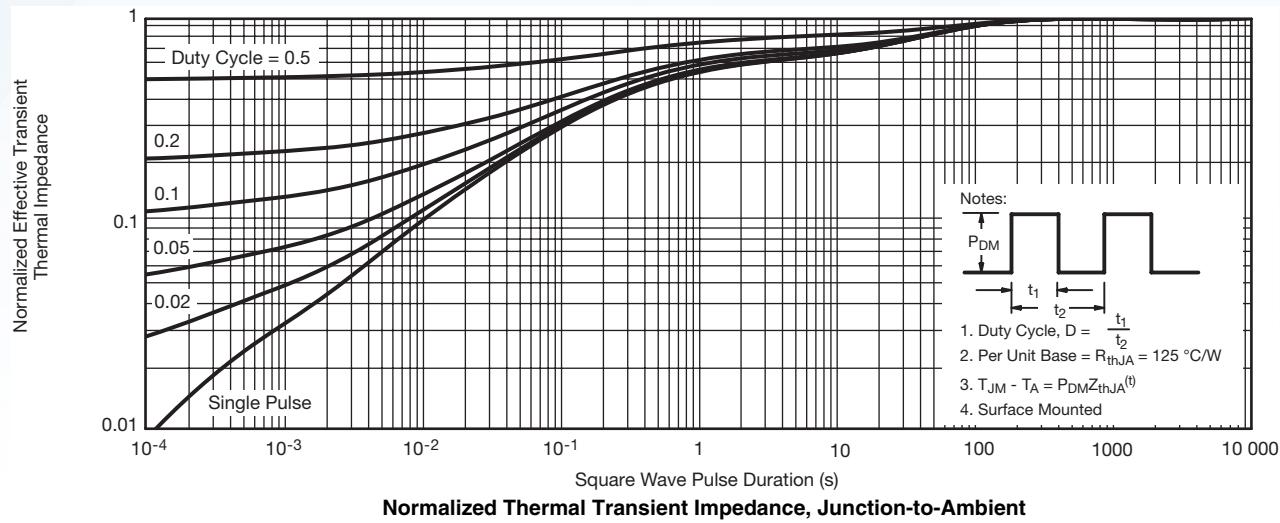
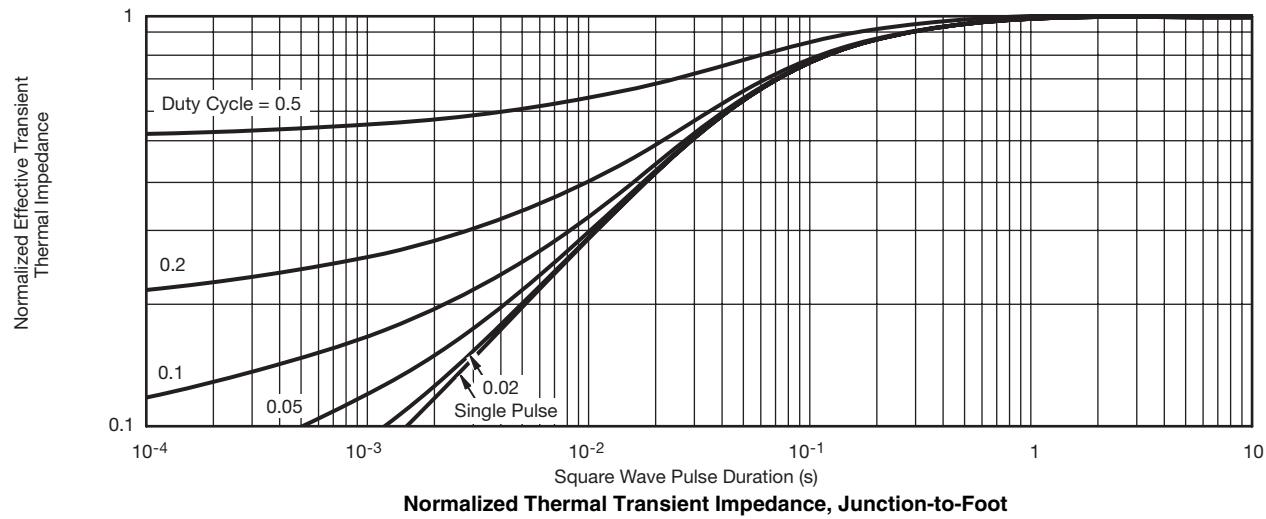
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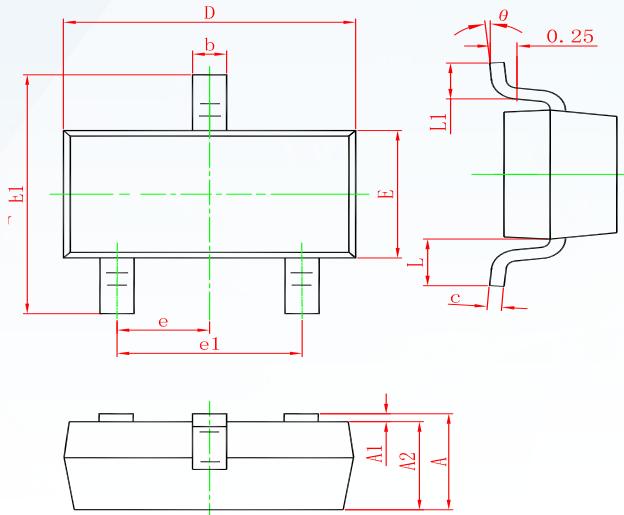
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



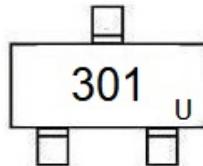
**N-Channel 20 V (D-S) MOSFET**
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted
**Current Derating\*****Power Derating, Junction-to-Foot****Power Derating, Junction-to-Ambient**

\* The power dissipation  $P_D$  is based on  $T_{J(\max.)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

**N-Channel 20 V (D-S) MOSFET**
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

**Normalized Thermal Transient Impedance, Junction-to-Ambient**

**Normalized Thermal Transient Impedance, Junction-to-Foot**

**N-Channel 20 V (D-S) MOSFET**
**SOT-23 PACKAGE OUTLINE DIMENSIONS**


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP.		0.037 TYP.	
e1	1.800	2.000	0.071	0.079
L	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020
θ	0°		8°	

**Marking**

**Ordering information**

Order code	Package	Baseqty	Deliverymode
FDV301N	SOT-23	3000	Tape and reel

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